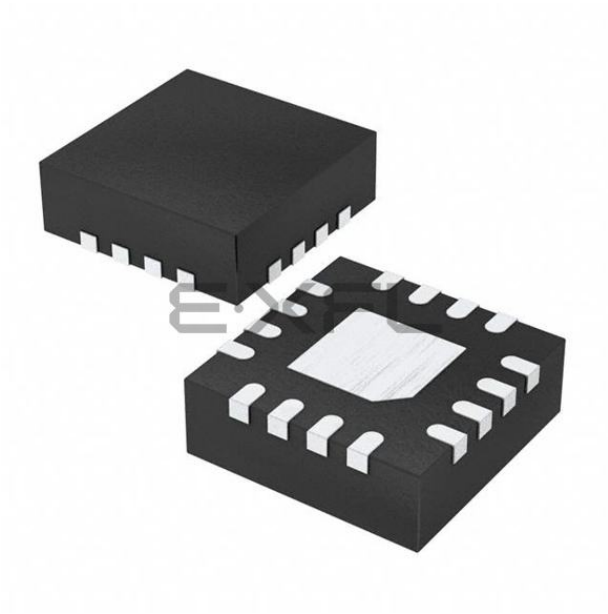

Welcome to E-XFL.COM

What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	11
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	64 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	16-VQFN Exposed Pad
Supplier Device Package	16-QFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f610t-i-ml

TABLE 1-2: PIC16F616/16HV616 PINOUT DESCRIPTION

Name	Function	Input Type	Output Type	Description
RA0/AN0/C1IN+/ICSPDAT	RA0	TTL	CMOS	PORTA I/O with prog. pull-up and interrupt-on-change
	AN0	AN	—	A/D Channel 0 input
	C1IN+	AN	—	Comparator C1 non-inverting input
	ICSPDAT	ST	CMOS	Serial Programming Data I/O
RA1/AN1/C12IN0-/VREF/ICSPCLK	RA1	TTL	CMOS	PORTA I/O with prog. pull-up and interrupt-on-change
	AN1	AN	—	A/D Channel 1 input
	C12IN0-	AN	—	Comparators C1 and C2 inverting input
	VREF	AN	—	External Voltage Reference for A/D
	ICSPCLK	ST	—	Serial Programming Clock
RA2/AN2/T0CKI/INT/C1OUT	RA2	ST	CMOS	PORTA I/O with prog. pull-up and interrupt-on-change
	AN2	AN	—	A/D Channel 2 input
	T0CKI	ST	—	Timer0 clock input
	INT	ST	—	External Interrupt
	C1OUT	—	CMOS	Comparator C1 output
RA3/$\overline{\text{MCLR}}$/VPP	RA3	TTL	—	PORTA input with interrupt-on-change
	$\overline{\text{MCLR}}$	ST	—	Master Clear w/internal pull-up
	VPP	HV	—	Programming voltage
RA4/AN3/$\overline{\text{T1G}}$/OSC2/CLKOUT	RA4	TTL	CMOS	PORTA I/O with prog. pull-up and interrupt-on-change
	AN3	AN	—	A/D Channel 3 input
	$\overline{\text{T1G}}$	ST	—	Timer1 gate (count enable)
	OSC2	—	XTAL	Crystal/Resonator
	CLKOUT	—	CMOS	FOSC/4 output
RA5/T1CKI/OSC1/CLKIN	RA5	TTL	CMOS	PORTA I/O with prog. pull-up and interrupt-on-change
	T1CKI	ST	—	Timer1 clock input
	OSC1	XTAL	—	Crystal/Resonator
	CLKIN	ST	—	External clock input/RC oscillator connection
RC0/AN4/C2IN+	RC0	TTL	CMOS	PORTC I/O
	AN4	AN	—	A/D Channel 4 input
	C2IN+	AN	—	Comparator C2 non-inverting input
RC1/AN5/C12IN1-	RC1	TTL	CMOS	PORTC I/O
	AN5	AN	—	A/D Channel 5 input
	C12IN1-	AN	—	Comparators C1 and C2 inverting input
RC2/AN6/C12IN2-/P1D	RC2	TTL	CMOS	PORTC I/O
	AN6	AN	—	A/D Channel 6 input
	C12IN2-	AN	—	Comparators C1 and C2 inverting input
	P1D	—	CMOS	PWM output
RC3/AN7/C12IN3-/P1C	RC3	TTL	CMOS	PORTC I/O
	AN7	AN	—	A/D Channel 7 input
	C12IN3-	AN	—	Comparators C1 and C2 inverting input
	P1C	—	CMOS	PWM output
RC4/C2OUT/P1B	RC4	TTL	CMOS	PORTC I/O
	C2OUT	—	CMOS	Comparator C2 output
	P1B	—	CMOS	PWM output
RC5/CCP1/P1A	RC5	TTL	CMOS	PORTC I/O
	CCP1	ST	CMOS	Capture input/Compare output
	P1A	—	CMOS	PWM output
VDD	VDD	Power	—	Positive supply
VSS	VSS	Power	—	Ground reference

Legend: AN = Analog input or output; CMOS = CMOS compatible input or output; HV = High Voltage; ST = Schmitt Trigger input with CMOS levels; TTL = TTL compatible input; XTAL = Crystal

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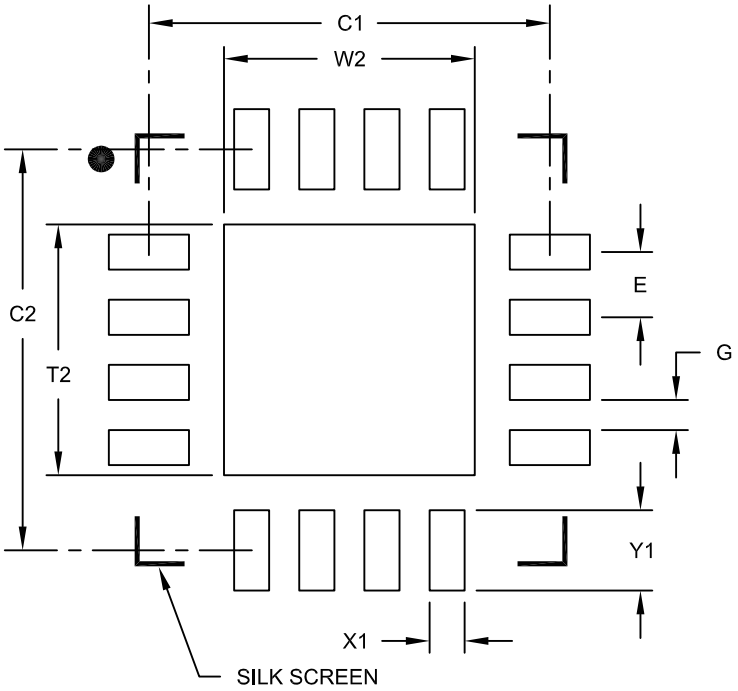
16-Lead Plastic Quad Flat, No Lead Package (ML) - 4x4x0.9mm Body [QFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.65 BSC	
Optional Center Pad Width	W2			2.50
Optional Center Pad Length	T2			2.50
Contact Pad Spacing	C1		4.00	
Contact Pad Spacing	C2		4.00	
Contact Pad Width (X28)	X1			0.35
Contact Pad Length (X28)	Y1			0.80
Distance Between Pads	G	0.30		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2127A